P-Channel 60 V (D-S) MOSFET

Description：

This P-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge. It can be used in a wide variety of applications.

Features：

1) V_{DS}=-60V, I_D=-30A, $R_{DS(ON)}$<35mΩ @V_{GS}=-10V

2) Low gate charge.

3) Green device available.

4) Advanced high cell denity trench technology for ultra $R_{DS(ON)}$.

5) Excellent package for good heat dissipation.

TO-252
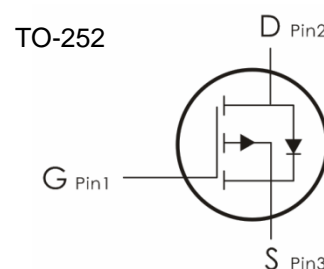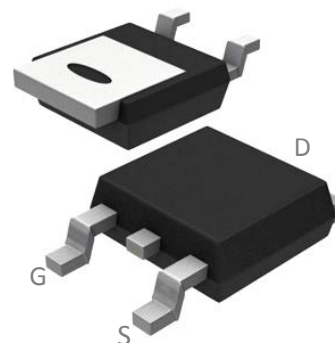
Absolute Maximum Ratings： (T_C=25℃ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Continuous Drain Current	-30	A
	Continuous Drain Current-TC=100℃	-19	
	Pulsed Drain Current[1]	---	
E_{AS}	Single Pulse Avalanche Energy	225	mJ
P_D	Power Dissipation	50	W
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +175	℃

Thermal Characteristics：

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	3	℃/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	42	

Electrical Characteristics：(T_C=25℃ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Sourtce Breakdown Voltage	V_{GS}=0V,I_D=250μA	-60	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{GS}=0V, V_{DS}=-60V	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	V_{GS}=±20V, V_{DS}=0A	---	---	±100	nA
On Characteristics						
$V_{GS(th)}$	GATE-Source Threshold Voltage	V_{GS}=V_{DS}, I_D=250μA	-1	-1.8	-2.5	V
$R_{DS(ON)}$	Drain-Source On Resistance②	V_{GS}=-10V,I_D=-15A	---	26	35	mΩ
		V_{GS}=-4.5V,I_D=-10A	---	32	40	
G_{FS}	Forward Transconductance	V_{DS}=-10V, I_D=-15A	---	---	---	S
Dynamic Characteristics						
C_{iss}	Input Capacitance		---	2535	---	pF
C_{oss}	Output Capacitance	V_{DS}=-30V, V_{GS}=0V, f=1MHz	---	130		
C_{rss}	Reverse Transfer Capacitance		---	75		
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time		---	14	---	ns
t_r	Rise Time	V_{DD}=-30V, I_D=-10A,	---	18	---	ns
$t_{d(off)}$	Turn-Off Delay Time	R_{GEN}=6.8Ω , V_{GS}=-10V	---	42	---	ns
t_f	Fall Time		---	15	---	ns
Q_g	Total Gate Charge		---	46	---	nC
Q_{gs}	Gate-Source Charge	V_{GS}=-10V, V_{DS}=-30V,	---	11	---	nC
Q_{gd}	Gate-Drain "Miller" Charge	I_D=-10A	---	10	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Source-Drain Diode Forward Voltage	V_{GS}=0V,I_S=-15A, T_J=25℃	---	-0.88	-1.2	V

t_{rr}	Reverse Recovery Time	I_{Sd}=-20A, V_{GS}=0V	---	28	---	ns
Q_{rr}	Reverse Recovery Charge	.dI/dt=-500A/µs	---	165	---	nc

Notes:

1. Repetitive rating; pulse width limited by max. junction temperature.

2. Pulse width$\leqq$ 300 µs; duty cycle $\leqq$ 2%.

3 . Limited by TJmax, starting TJ = 25¡ãC, L = 0.5mH,RG = 25 Ω , , IAS = -32A, VGS =-10V. Part not recommended for use above this value

Typical Characteristics： (T$_C$=25℃ unless otherwise noted)
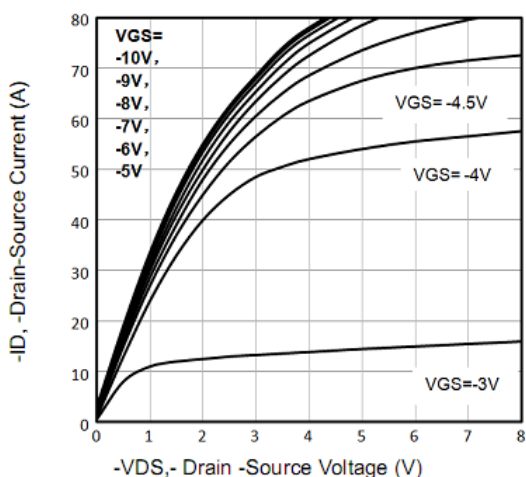
Fig1. Typical Output Characteristics
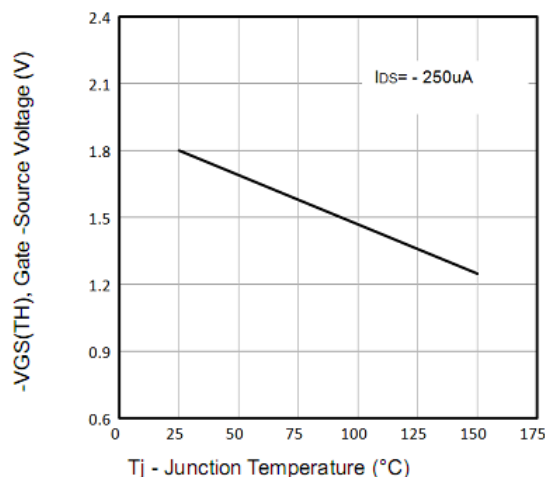
Fig2. -VGS(TH) Gate -Source Voltage Vs.Tj
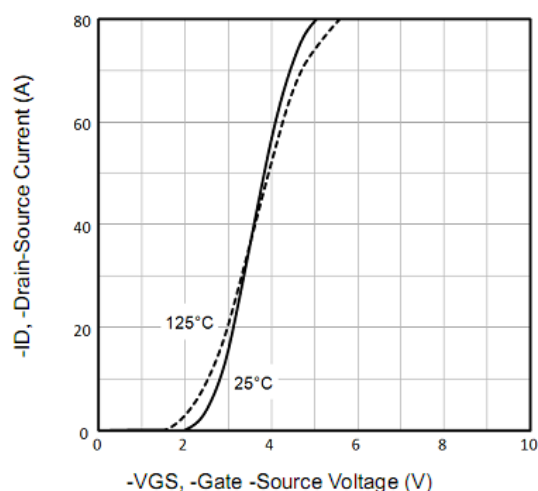
Fig3. Typical Transfer Characteristics
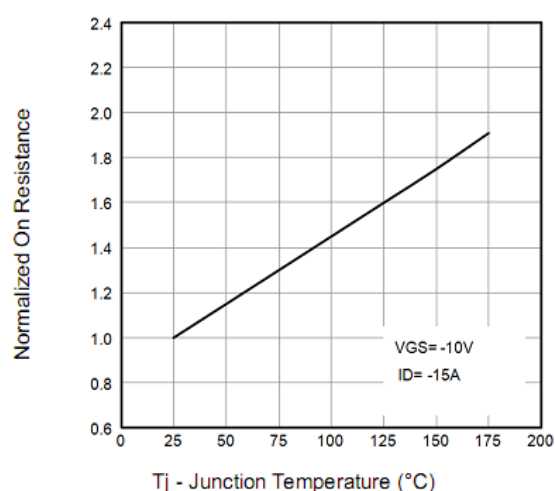
Fig4. Normalized On-Resistance Vs. Tj
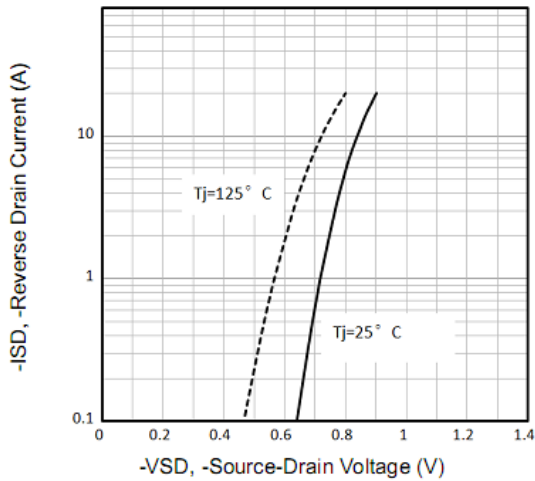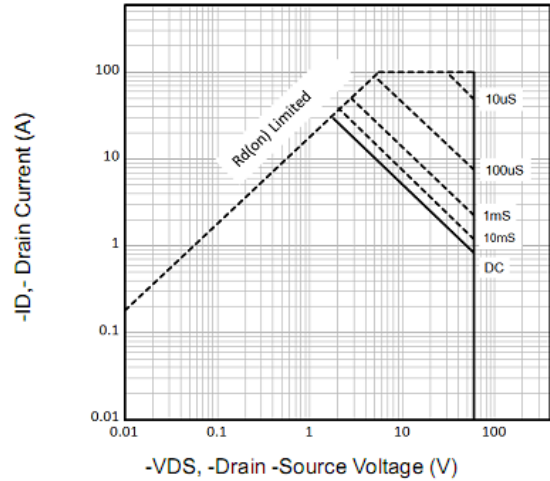
Fig5. Typical Source-Drain Diode Forward Voltage
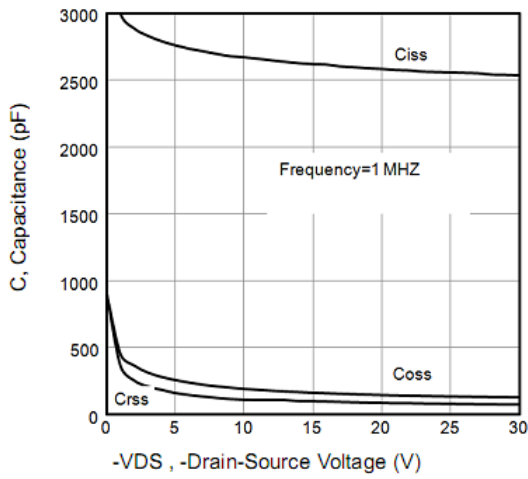
Fig6. Maximum Safe Operating Area
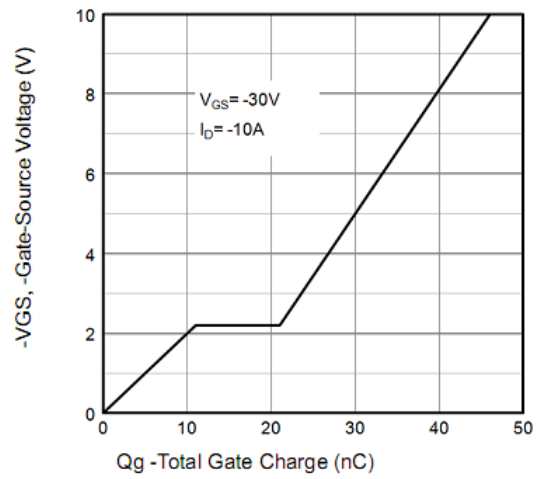
Fig7. Typical Capacitance Vs.Drain-Source Voltage

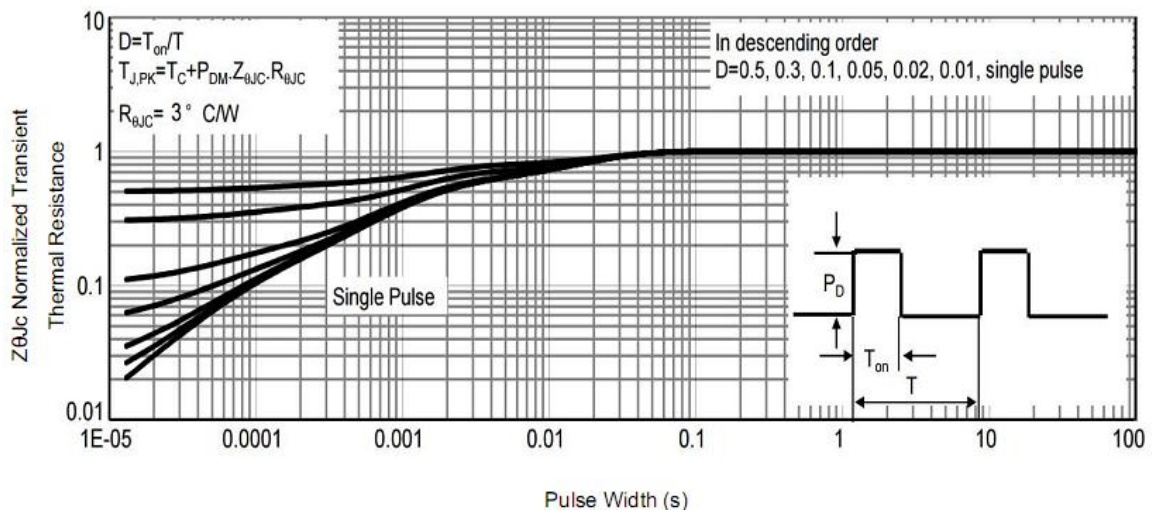Fig8. Typical Gate Charge Vs.Gate-Source Voltage
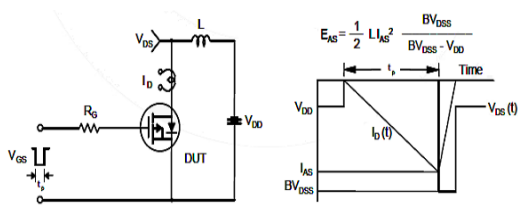
Fig9. Normalized Maximum Transient Thermal Impedance
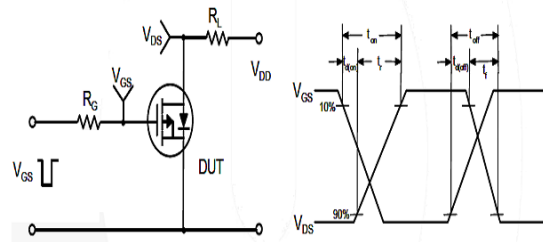
Fig10. Unclamped Inductive Test Circuit and Waveforms   Fig11. Switching Time Test Circuit and waveforms

外形尺寸图 / **Package Dimensions**